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## QianLi 73 Piece Complete Pack of Reballing Stencils For Phone IC Chip Repair

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Product ID: 22654

Price: **249.00 EUR**

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Product weight: **1.50 kg**

### Description:

QianLi 73 Piece Complete Pack of Reballing Stencils For Phone IC Chip Repair This complete pack of stencils is ideal for any professional phone repair technician wishing to reball chips from a massive range of phones. Also you save money buying a pack this side, rather than individual stencils.

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